

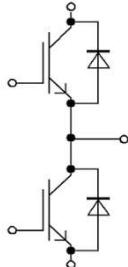
# SF150R12A6



34mm module with IGBT and Diode

## Features:

- 1200V Trench & Field stop technology
- Low switching losses
- Positive temperature coefficient



## IGBT, Inverter

V<sub>CES</sub> = 1200V, I<sub>C nom</sub> = 150A / I<sub>CRM</sub> = 300A

## Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
Collector-Emitter voltage	T <sub>vj</sub> =25°C	V <sub>CES</sub>	1200		V
Continuous DC collector current	T <sub>C</sub> =100°C, T <sub>vj max</sub> =175°C	I <sub>C nom</sub>	150		A
Repetitive peak collector current	t <sub>p</sub> =1 ms	I <sub>CRM</sub>	300		A
Total power dissipation	T <sub>C</sub> = 25°C, T <sub>vj max</sub> = 175°C	P <sub>tot</sub>	789		W
Gate emitter voltage		V <sub>GE</sub>	±20		V

## Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	V <sub>GE</sub> =15V, I <sub>C</sub> =150A	V <sub>CEsat</sub>	1.97	2.36	2.44	V
	V <sub>GE</sub> =15V, I <sub>C</sub> =150A					
	V <sub>GE</sub> =15V, I <sub>C</sub> =150A					
Gate-Emitter threshold voltage	I <sub>C</sub> =3.2mA, V <sub>GE</sub> = V <sub>CE</sub>	T <sub>vj</sub> =25°C	V <sub>GE(th)</sub>	5.7		
Gate charge	V <sub>GE</sub> =-15V...+15V		Q <sub>G</sub>	1.09		µC
Internal gate resistor			R <sub>Gint</sub>	3.6		Ω
Input capacitance			C <sub>ies</sub>	11.7		nF
Output capacitance	f=1 MHz, V <sub>CE</sub> =25 V, V <sub>GE</sub> =0 V	T <sub>vj</sub> =25°C	C <sub>oes</sub>	0.925		
Reverse transfer capacitance			C <sub>res</sub>	0.410		nF
Collector-emitter cut-off current	V <sub>CE</sub> =1200V , V <sub>GE</sub> = 0 V	T <sub>vj</sub> =25°C	I <sub>CES</sub>	1	mA	

# SF150R12A6

Gate-emitter leakage current	$V_{CE}=0$ V, $V_{GE}= 20$ V	$T_{vj}=25^\circ C$	$I_{GES}$		100	nA
Turn-on delay time	$I_c=150A$ , $V_{CE}=600$ V $V_{GE}=\pm 15$ V, $R_G=3.6\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	$t_{d\ on}$		140 150 160	
Rise time	$I_c=150A$ , $V_{CE}=600$ V $V_{GE}=\pm 15$ V, $R_G=3.6\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	$t_r$		40 45 45	
Turn-off delay time	$I_c=150A$ , $V_{CE}=600$ V $V_{GE}=\pm 15$ V, $R_G=3.6\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	$t_{d\ off}$		220 310 320	
Fall time	$I_c=150A$ , $V_{CE}=600$ V $V_{GE}=\pm 15$ V, $R_G=3.6\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	$t_f$		200 280 280	
Turn-on energy loss per pulse	$I_c=150A$ , $V_{CE}=600$ V $V_{GE}=\pm 15$ V, $R_G=3.6\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	$E_{on}$		8.63 12.7 14.8	
Turn-off energy loss per pulse	$I_c=150A$ , $V_{CE}=600$ V $V_{GE}=\pm 15$ V, $R_G=3.6\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	$E_{off}$		8.77 16.1 16.8	
SC data	$V_{GE}\leq 15V$ , $V_{cc}=800V$ $V_{CEmax}=V_{CES} \cdot L_{SCE} \cdot di/dt$ $t_p \leq 10\mu s$ , $T_{vj}=150^\circ C$		$I_{sc}$		480	A
Thermal resistance, junction to case	per IGBT		$R_{thJC}$			K/W
Temperature under switching conditions			$T_{vj\ op}$	-40	150	°C

## Diode, Inverter

### Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
Repetitive peak reverse voltage	$T_{vj}=25^\circ C$	$V_{RRM}$	1200		V
Continuous DC forward current		$I_F$	150		A
Repetitive peak forward current	$t_p=1ms$	$I_{FRM}$	300		A

### Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F=150A$ , $V_{GE}=0V$	$V_F$		2.2		V
	$I_F=150A$ , $V_{GE}=0V$			2.26		
	$I_F=150A$ , $V_{GE}=0V$			2.17		
Peak reverse recovery current	$I_F=150A$ , $-di_F/dt=2700A/\mu s$ ( $T_{vj}=150^\circ C$ )	$I_{RM}$		80		A
	$V_R=600V$ , $V_{GE}=-15V$			95		
	$T_{vj}=150^\circ C$			100		
Recovered charge	$I_F=150A$ , $-di_F/dt=2700A/\mu s$ ( $T_{vj}=150^\circ C$ )	$Q_r$		6.5		$\mu C$
	$V_R=600V$ , $V_{GE}=-15V$			17.0		
	$T_{vj}=150^\circ C$			21.5		

# SF150R12A6

Reverse recovered energy	I <sub>F</sub> =150A, -dI/dt=2700A/μs(T <sub>vj</sub> =150°C) V <sub>R</sub> =600V, V <sub>GE</sub> =-15V	T <sub>vj</sub> =25°C T <sub>vj</sub> =125°C T <sub>vj</sub> =150°C	E <sub>rec</sub>		2.4 7.0 8.7		mJ
Thermal resistance, junction to case	Per diode		R <sub>thjc</sub>			0.32	K/W

## Module

Isolation test voltage	RMS, f = 50Hz, t = 1min	V <sub>ISOL</sub>	4	kV
Material module baseplate			Cu	
Mounting torque for modul mounting	to heat sink M6	M	3~5	Nm
Terminal connection torque	to terminals M5	M	2.5~5	Nm

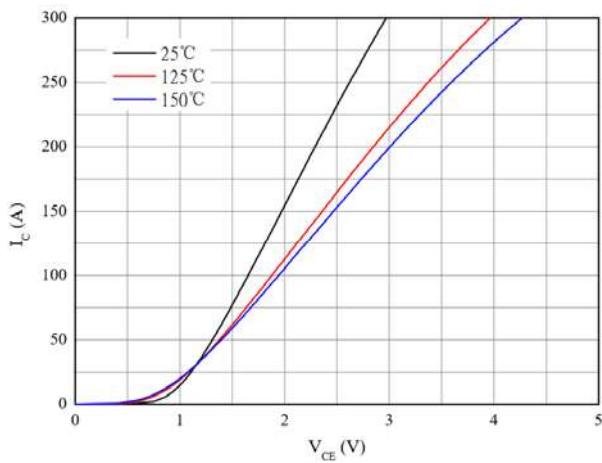


Figure 1. Typical output characteristics (V<sub>GE</sub>=15V)

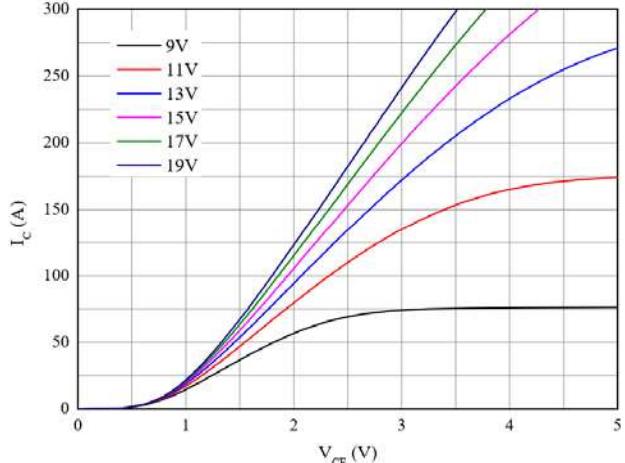


Figure 2. Typical output characteristics (T<sub>vj</sub>=150°C)

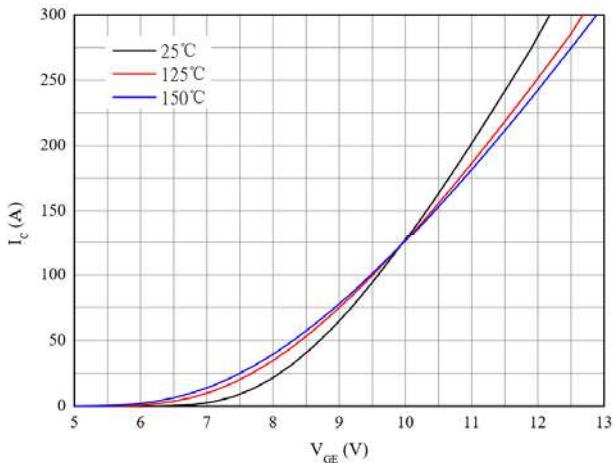


Figure 3. Typical transfer characteristic(V<sub>f</sub> =20V)

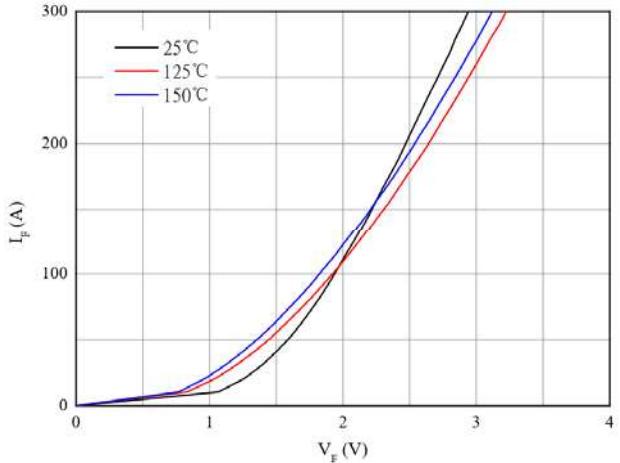


Figure 4. Forward characteristic of Diode

# SF150R12A6

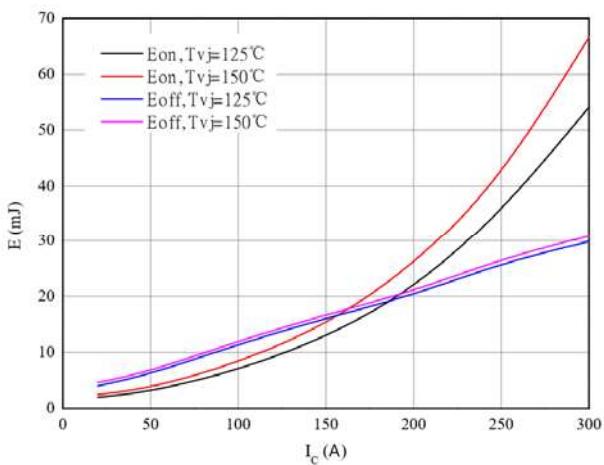


Figure 5. Switching losses of IGBT  
 $V_{GE} = \pm 15V$ ,  $R_{Gon} = 3.6\Omega$ ,  $R_{Goff} = 3.6\Omega$ ,  $V_{CE} = 600V$

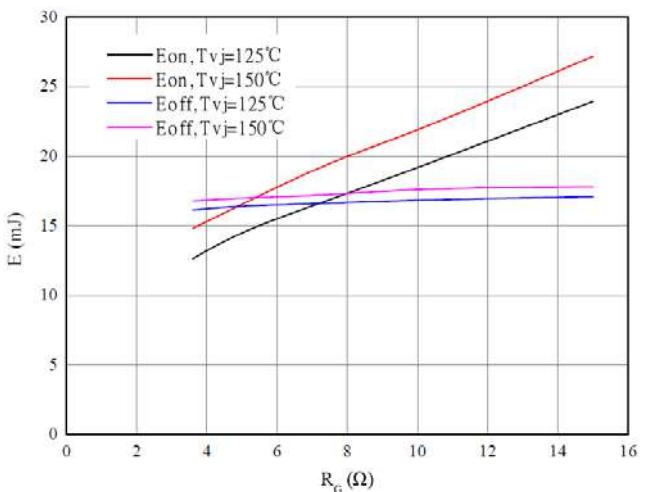


Figure 6. Switching losses of IGBT  
 $V_{GE} = \pm 15V$ ,  $I_C = 150A$ ,  $V_{CE} = 600V$

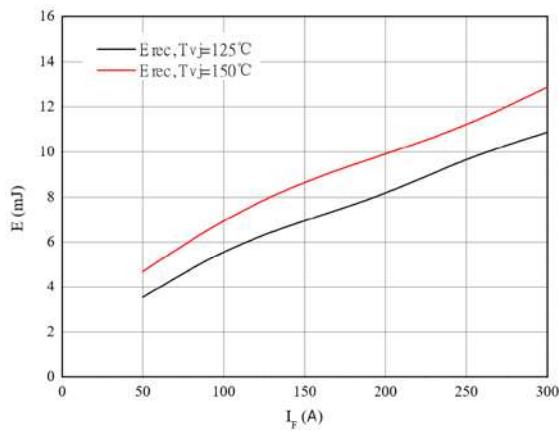


Figure 7. Switching losses of Diode  
 $R_{Gon} = 3.6\Omega$ ,  $V_{CE} = 600V$

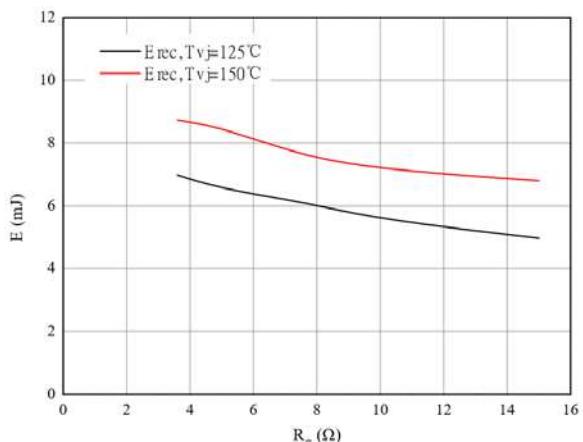


Figure 8. Switching losses of Diode  
 $I_F = 150A$ ,  $V_{CE} = 600V$

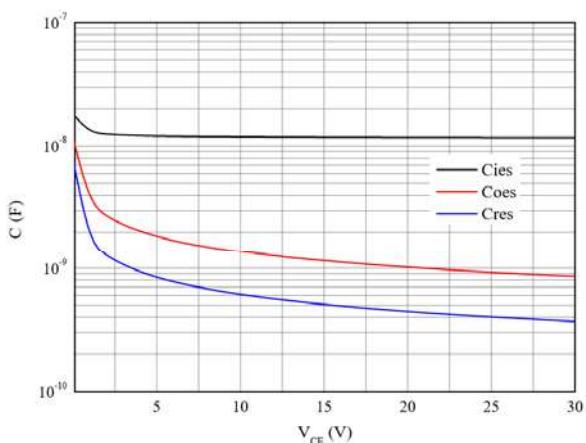
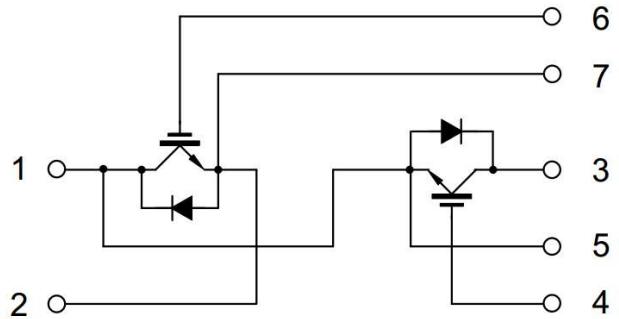


Figure 9. Capacitance characteristic

# SF150R12A6

## Circuit diagram



## Package outlines

